

# Call for Papers

The Journal of Chemical Product and Process Modeling is the premier forum for the presentation of technological advances and research results in the fields of product and process modeling and simulation from around the world. Topics of interest for submission are included, but are not limited to:

Equation oriented modeling and simulation (EOS)  
Sequential and modular simulation (SMS)  
Shortcut approach to chemical engineering product and process design and modeling  
Performance of industrial product and process simulators  
Modeling and simulation of non-ideal unit operations and processes  
Challenges faced by product and process simulators in modeling the industrial products and processes  
Computational fluid dynamics (CFD)  
Environmental and food process and product modeling (EFPM)  
Overlap between modeling and simulation  
Overlap between product and process modeling  
Industrial case studies  
Process and product data processing and analysis  
Product design and simulation  
New area of exploration and research in modeling and simulation  
Fundamentals  
Applied mathematics to process/product modeling and simulation  
Prospective authors are invited to submit their manuscripts through the Bepress web site. (<http://www.bepress.com/cppm>).

Best Regards,

Editors

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